

Tin-Absorbing Tape

Product Description

Crafted from high-purity oxygen-free copper, it boasts strong solder absorption capacity, efficiently removes residual solder from solder joints, and is ideal for small precision electronic repair scenarios.



Product Advantages

- Narrow width for precise fitting
- High-purity copper material
- Strong solder absorption
- Fast residual solder removal
- Designed specifically for precision repair

◆ Product Structure

High-purity oxygen-free copper wire tightly woven, special surface treatment, fixed width cutting, smooth edge without burrs, convenient hand-held operation

◆ Application Scenarios

Small circuit board maintenance, micro component desoldering, fine solder joint cleaning, portable digital product after-sales maintenance, small instrument welding assistance

◆ Technical Features

Tensile strength: $\geq 300 \text{ N/mm}^2$

Tin absorption rate: $\geq 1.2\text{g/min}$

Working temperature: $200\text{-}350 \text{ }^\circ\text{C}$

Copper purity: $\geq 99.9\%$

Item#	Weight	Packaging Method	Width
1.5.20.00.0006	0.0062kg	Individually wrapped	1.5mm
1.5.20.00.0007	0.0062kg	Individually wrapped	2.0mm
1.5.20.00.0008	0.011kg	Individually wrapped	2.5mm
1.5.20.00.0009	0.0092kg	Individually wrapped	3.0mm
1.5.20.00.0010	0.015kg	Individually wrapped	3.5mm

◆ Remarks

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